



SBR10U200P5

10A SBR[®]
SUPER BARRIER RECTIFIER
POWERDI[®]

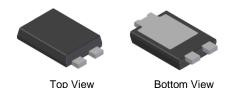
Features

- Ultra Low Forward Voltage Drop
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- · Soft, Fast Switching Capability
- +175°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe;
 Solderable per MIL-STD-202, Method 208 ³
- Polarity: See Diagram
- Weight: 0.093 grams (Approximate)

POWERDI®5



RIGHT PIN O BOTTOMSIDE HEAT SINK

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR10U200P5-13	POWERDI®5	5,000/Tape & Reel
SBR10U200P5Q-13	POWERDI [®] 5	5,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

POWERDI®5



S10U200 = Product Type Marking Code

Oli = Manufacturers' Code Marking

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 15 for 2015)

WW = Week Code (01 - 53)

K = Factory Designator



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}		
Working Peak Reverse Voltage	V_{RWM}	200	V
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current	lo	10	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	А
Repetitive Peak Avalanche Power (1µs, +25°C)	P _{ARM}	3,000	W

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)		$R_{\theta JA}$	70	°C/W
Typical Thermal Resistance Junction to Case (Note 5)		$R_{\theta JC}$	14	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)		$R_{\theta JA}$	20	°C/W
Typical Thermal Resistance Junction to Case (Note 6)		$R_{\theta JC}$	3	°C/W
Operating Temperature Range	Reverse Mode DC Forward Mode (Note 7)		-65 to +175 ≤200	°C
Storage Temperature Range		T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

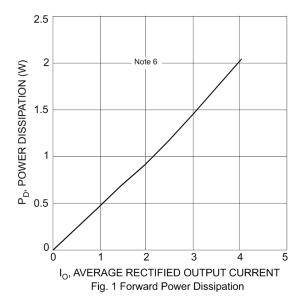
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
		_	0.75	0.82		$I_F = 5A$, $T_J = +25$ °C
Forward Voltage Drop	V_{F}	_	0.62	0.67	V	$I_F = 5A, T_J = +125$ °C
		_	0.83	0.88		I _F = 10A, T _J = +25°C
Leakage Current (Note 8) I _R		_	0.1	mA	V _R = 200V, T _J = +25°C	
	IR	_	0.18	10	IIIA	$V_R = 200V, T_J = +125$ °C

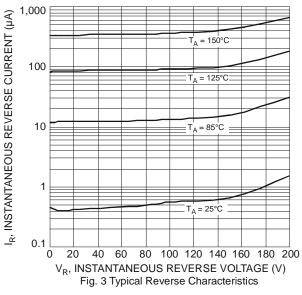
Notes:

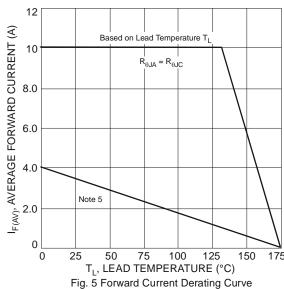
- Device mounted on FR4 PCB with minimum recommended pad layout per http://www.diodes.com.
 Device mounted on FR4 PCB with 1-inch pad layout and additional HK2(45mm x 20mm x12mm).
 Max junction temperature guaranteed for 2 hours.

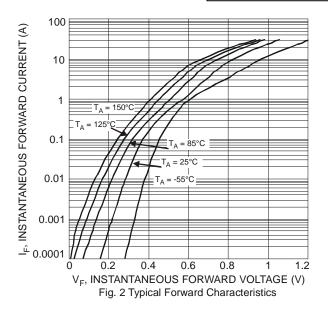
- 8. Short duration pulse test used to minimize self heat effect.

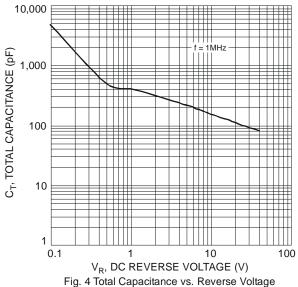






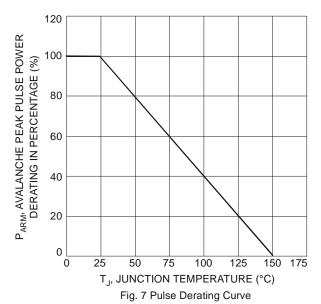












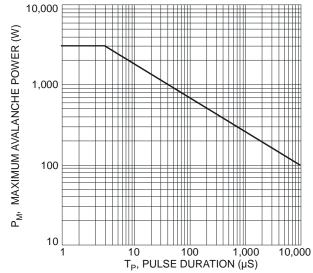
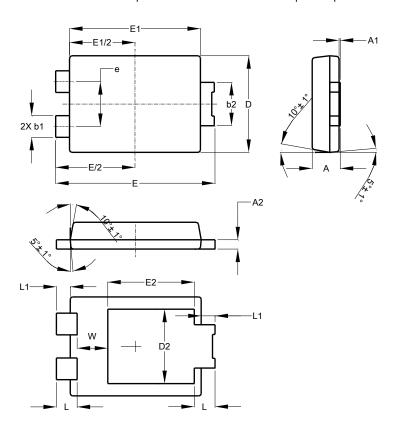


Fig. 8 Maximum Avalanche Power vs. Pulse Duration



Package Outline Dimensions

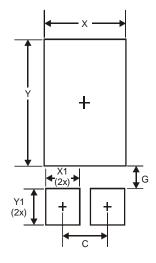
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



POWERDI [®] 5					
Dim	Min	Max	Тур		
Α	1.05	1.15	1.10		
A2	0.33	0.43	0.381		
b1	0.80	0.99	0.89		
b2	1.70	1.88	1.78		
D	3.90	4.05	3.966		
D2	-	-	3.054		
Е	6.40	6.60	6.504		
е	-	-	1.84		
E1	5.30	5.45	5.37		
E2	-	-	3.549		
L	0.75	0.95	0.85		
L1	0.50	0.65	0.57		
W	1.10	1.41	1.255		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	1.840
G	0.852
X	3.360
X1	1.390
Y	4.860
Y1	1.400



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